

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	("5914531").PN.	USPAT	OR	OFF	2005/04/29 15:20
L2	2591	(@ad<"20010110") and (wafer with (cap or caps or sink or sinks or spreaders or spreader))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/29 15:27
L3	684	L2 and (cut or cutting or saw or sawing or dice)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/29 15:27
L4	9669	(@ad<"20010110") and (wafer with (lid or cover or hermetic or cap or caps or sink or sinks or spreaders or spreader))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/29 16:16
L5	2296	L4 and (cut or cutting or saw or sawing or dice)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/29 15:28
L6	630	L5 and (mold or molding or encapsulant or encapsulate or epoxy)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/29 15:29
L7	16	("20010003377"   "5061987"   "5285131"   "5551903"   "5610438"   "5614353"   "5767575"   "5895233"   "5915168"   "6020212"   "6051866"   "6093330"   "6142358"   "6192757"   "6214644"   "6228675").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/04/29 15:34
L8	7	("4990814"   "5059848"   "5567656"   "5583373"   "5593927"   "5604160"   "5610431").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/04/29 15:46
L9	52	("5915168").URPN.	USPAT	OR	OFF	2005/04/29 15:46
L10	7	("5388443").URPN.	USPAT	OR	OFF	2005/04/29 16:04
L11	12	("4907065").URPN.	USPAT	OR	OFF	2005/04/29 16:10
L12	12	("4907065").URPN.	USPAT	OR	OFF	2005/04/29 16:12

L13	4	("4355463"   "4398208"   "4672418"   "4731699").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/04/29 16:13
L14	955682	(@ad<"20010110"):and wafer ((lower or position or press) with (lid or cover or hermetic or cap or caps or sink or sinks or spreaders or spreader))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/29 16:17
L15	5925	(@ad<"20010110") and wafer and ((lower or position or press) with (lid or cover or hermetic or cap or caps or sink or sinks or spreaders or spreader))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/29 16:17
L16	807	(@ad<"20010110") and wafer and ((lower or position or press) near (lid or cover or hermetic or cap or caps or sink or sinks or spreaders or spreader))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/29 16:19
L17	569	L16 and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/29 16:19
L18	1087	(@ad<"20010110") and wafer and ((place or placement or align or lower or position or press) near (lid or cover or hermetic or cap or caps or sink or sinks or spreaders or spreader))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/29 16:19
L19	1097	(@ad<"20010110") and wafer and ((place or placement or align or lower or position or press or push) near (lid or cover or hermetic or cap or caps or sink or sinks or spreaders or spreader))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/29 16:19
L20	738	L19 and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/29 16:19